Panasonic MTM232270LBF

MTM232270LBF

Silicon N-channel MOSFET

For switching

MTM13227 in SMini3 type package

■ Features

- Low drain-source ON resistance:RDS(on) typ. = 85 m Ω (VGS = 4.0 V)
- Low drive voltage: 2.5 V drive
- Halogen-free / RoHS compliant

(EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: ET

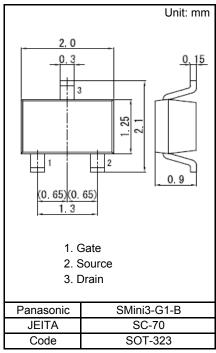
■ Packaging

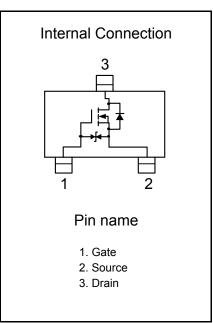
MTM232270LBF Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Drain-source Voltage	VDS	20	V
Gate-source Voltage	VGS	±10	V
Drain current	ID	2.0	Α
Drain Current (Pulsed) *1	IDp	8	Α
Total Power Dissipation *2	PD	500	mW
Channel Temperature	Tch	150	°C
Storage Temperature Range	Tstg	-55 to +150	°C

Note: *1 Pulse width \leq 10 μ s, Duty cycle \leq 1%





^{*2} Measuring on ceramic board at 40 mm \times 38 mm \times 0.1 mm. Absolute maximum rating PD without heat sink shall be made 150 mW.

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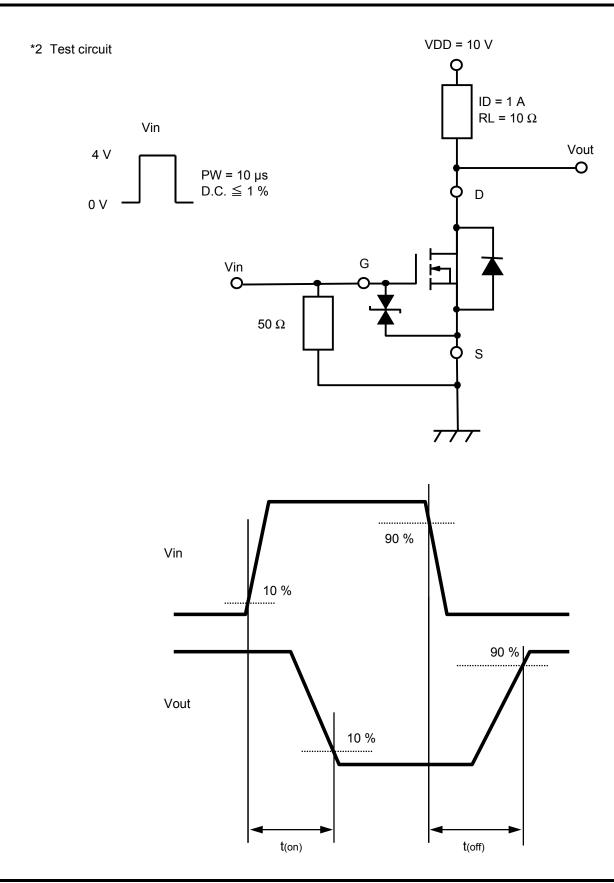
■ Electrical Characteristics Ta = 25°C±3°C

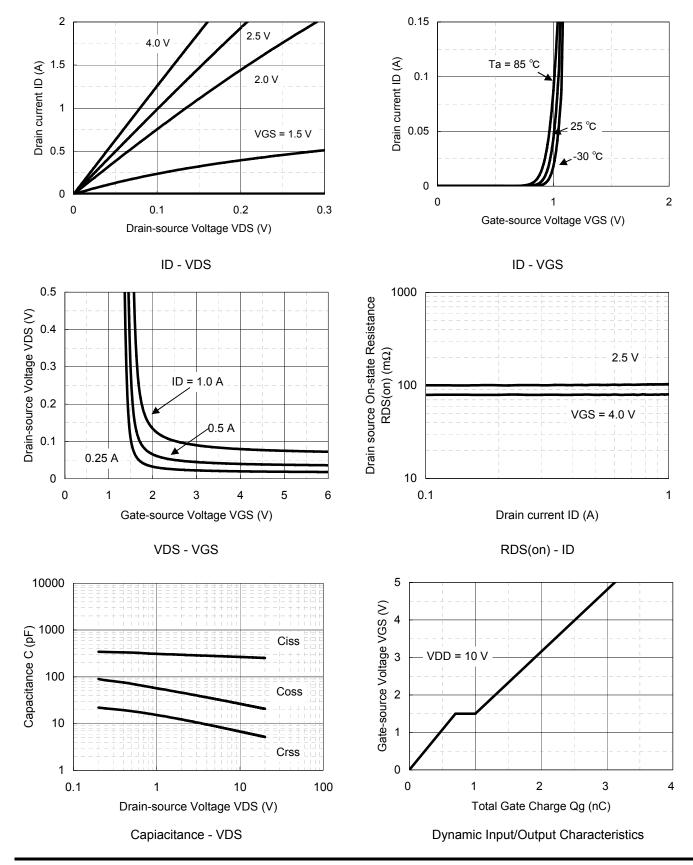
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source Breakdown Voltage	VDSS	ID = 1 mA, VGS = 0 V	20			V
Zero Gate Voltage Drain Current	IDSS	VDS = 20 V, VGS = 0 V			10	μΑ
Gate-source Leakage Current	IGSS	VGS = ±8 V, VDS = 0 V			±10	μΑ
Gate-source Threshold Voltage	Vth	ID = 1.0 mA, VDS = 10 V	0.4	0.85	1.3	V
Drain to Source On-State Resistance *1	RDS(on)1	ID = 1 A, VGS = 4 V		85	110	mΩ
	RDS(on)2	ID = 0.5 A, VGS = 2.5 V		100	150	
Forward transfer admittance *1	Yfs	ID = 1 A, VDS = 10 V, f = 1 kHz	3.0			S
Input Capacitance	Ciss			290		pF
Output Capacitance	Coss	VDS = 10 V, VGS = 0, f = 1 MHz		26		
Reverse Transfer Capacitance	Crss			20		
Turn-on Time *2	ton	VDD = 10 V, VGS = 0 to 4 V, ID = 1 A		12		ns
Turn-off Time *2	toff	VDD = 10 V, VGS = -4 to 0 V, ID = 1 A		60		ns

Note: Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

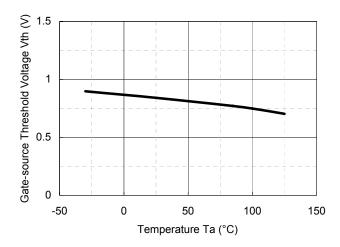
^{*1} Pulse test : Pulse width \leq 10 μs , Duty cycle \leq 1 %

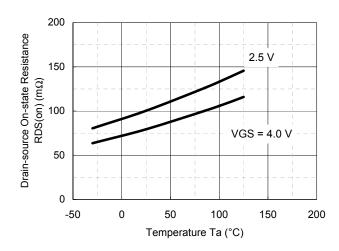
^{*2} See test circuit

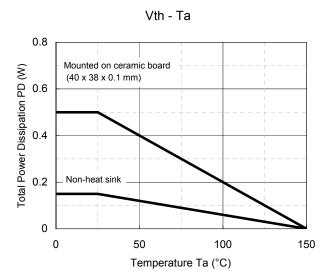




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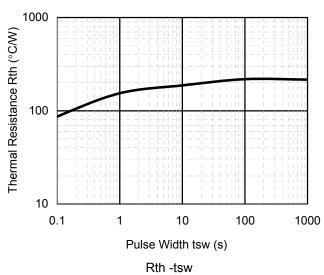


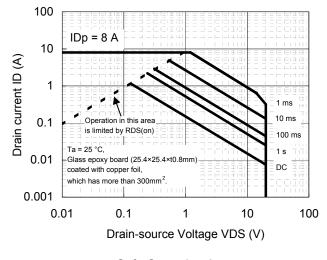




RDS(on) - Ta

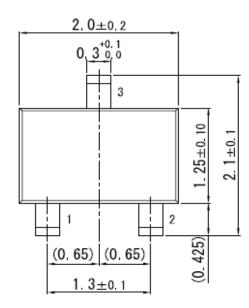




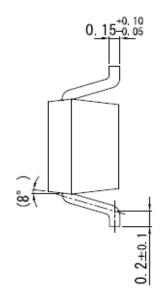


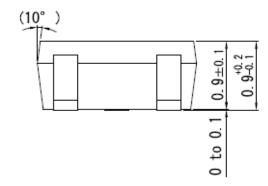
Safe Operating Area

SMini3-G1-B

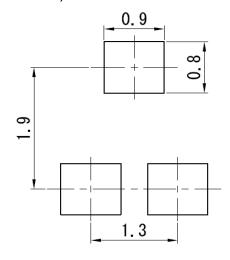


Unit: mm





■ Land Pattern (Reference) (Unit: mm)



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